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Charge Distribution and Contact Resistance Model for Coplanar Organic Field-Effect Transistors

Chang Hyun Kim, *Student Member, IEEE*, Yvan Bonnassieux, and Gilles Horowitz

Abstract

We propose a theoretical description of the charge distribution and the contact resistance in coplanar organic field-effect transistors (OFETs). Based on the concept that the current in organic semiconductors is only carried by injected carriers from the electrodes, an analytical formulation for the charge distribution inside the organic layer was derived. We found that the contact resistance in coplanar OFETs arises from a sharp low-carrier-density zone at the source/channel edge because the gate-induced channel carrier density is orders of magnitude higher than the source carrier density. This image is totally different from the contact resistance in staggered OFETs, in which the contact resistance mainly originates from the resistance through the semiconductor bulk. The contact resistance was calculated through charge-distribution functions and the model could explain the effect of the gate voltage and injection barrier on the contact resistance. Experimental data on pentacene OFETs were analyzed using the transmission-line method. We finally noticed that the gate-voltage dependent mobility is a critical factor for proper understanding of the contact resistance in real devices.

Index Terms

Charge distribution, contact resistance, coplanar OFETs, physical modeling.

I. INTRODUCTION

IN SPITE OF impressive advances in organic electronic devices, theoretical understanding of their operation is still incomplete. Organic field-effect transistors (OFETs), which are of great importance for low-cost flexible electronics, need more fundamental insights for further breakthroughs [1]. Among other interesting features of OFETs, contact resistance (R_c) effect is decisive because there exists a substantial injection barrier in most realistic metal/organic junctions. In other words, even if one might choose a metal of which the Fermi level is very close to the transport orbital (HOMO or LUMO) of the organic material, process contamination and formation of interface trap states generally result in a Fermi level pinning so that the injection barrier cannot vanish below certain level [2], [3].

It is widely accepted that device geometry plays a crucial role for R_c and comparative experiments on staggered and coplanar structures have been reported [4], [5]. Fig. 1 illustrates four common device geometries of OFETs. Typically, staggered OFETs showed smaller R_c than coplanar OFETs. This tendency was tentatively explained by various concepts including metal penetration into organic films [6] and lateral morphological variation of polycrystalline film [5], [7]. In both geometries, R_c seemed to be also dependent on the applied gate voltage (V_G) with its magnitude decreasing with increasing $|V_G|$. Several models based on the current crowding mechanism have been invoked to explain the V_G dependence of R_c in staggered OFETs [8], [9], [10], [11]. However, no such consummate operation model exists for the origin and the V_G -dependence of R_c in coplanar OFETs. The coplanar structure is more frequently adopted than the staggered one in fabrication. This is due to the fact that people prefer to avoid metal-deposition damage on a ‘fragile’ organic film in bottom-gate configuration. Therefore, a specific model for coplanar OFETs is highly desired. Concerning the geometrical effect on R_c , we recently observed that, apart from the above-mentioned process-related factors, there is a fundamental difference in the ‘charge distribution’ in staggered and coplanar organic transistors and this fact implies an underlying physical background of the dissimilar contact behaviors [12].

Here, we propose a physical device model for coplanar OFETs. Analytical equations for the two-dimensional charge distribution are developed by solving Poisson’s and transport equations and by applying boundary conditions for a finite-thickness semiconductor. The carrier-density in the transition zone at the source/channel interface is modeled to build up a formulation of R_c as an integration of the local resistivity. Numerically calculated R_c clearly shows the influence of V_G and injection barrier height (E_b) on the determination of R_c . Experimental data on coplanar OFETs are analyzed by testing coplanar pentacene transistors. By applying the transmission-line method (TLM) to the measurement results, it is revealed that the V_G -dependence of mobility is another pivotal factor that should be taken into account.

II. EXPERIMENTAL AND MODELING METHODS

Pentacene-based coplanar OFETs were fabricated with the structure equivalent to the the model transistor in Fig. 2. The bottom-gate electrode was prepared by a deposition of Cr on a glass substrate. A chemically and mechanically stable epoxy-based photoresist SU-8 was used as a gate insulator. A diluted SU-8 solution (SU-8 2050 product of MicroChem) was

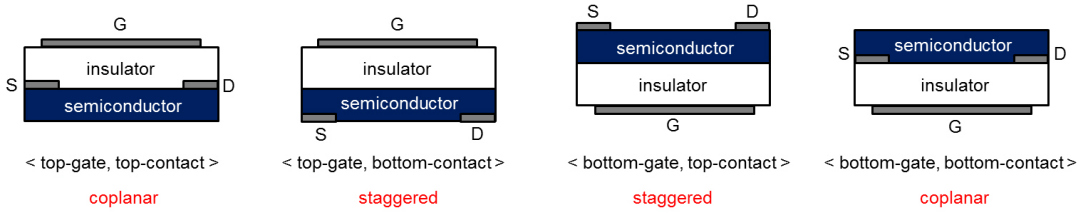


Fig. 1. Four OFET structures characterized by the relative positions of the gate (G) and the source/drain (S/D) electrodes. By definition, the source/drain electrodes in coplanar OFETs are on the same plane with the conducting channel. In the staggered structure, on the contrary, the semiconducting layer separates the source/drain electrodes from the channel. The model presented in this study is applicable to the two coplanar structures.

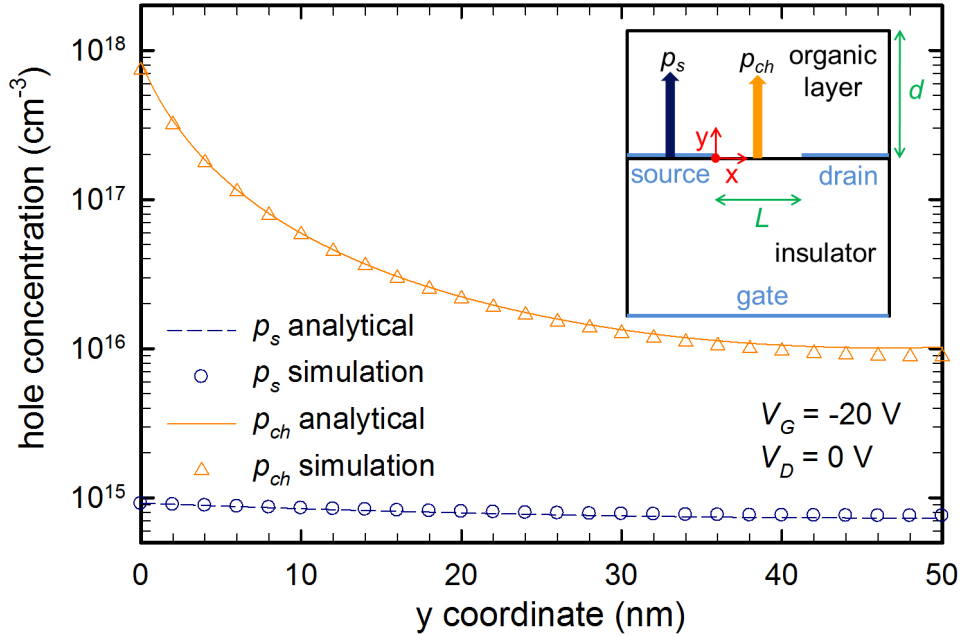


Fig. 2. Charge distribution inside the organic semiconductor of a coplanar-type OFET. The analytical curves are obtained by (15), (17), (23), and (27). Note that the device simulator brings very close results.

spin-coated on the substrate and UV-exposed to activate the cross-linking reaction. The processed film was hard-baked at 200 °C for 2 minutes. This method gave a 950 nm-thick polymeric film with the gate capacitance of 2.3 nF/cm². The source/drain electrodes were then formed by depositing Au followed by a photolithographical patterning step. Pentacene (99.9+% purity, used as-received from Sigma-Aldrich) was finally vacuum-evaporated to form a hole-transporting molecular film. During the thermal evaporation of pentacene, the substrate was heated at 50 °C and the deposition rate was kept at 0.1 nm/s with the final thickness of 50 nm. We have recently estimated the quasistatic dielectric constant of pentacene in [13] and the average value of 3.6 will be used in this study.

Current-voltage (I - V) characteristics were measured using a semiconductor characterization system (Keithley 4200) in the dark under ambient atmosphere. Tapping-mode atomic force microscopy (AFM) images of the pentacene film were taken using Veeco Dimension 5000 AFM system. Model calculations were performed with MATHCAD platform (Parametric Technology Corporation). To support the model, simulation results were taken through two-dimensional physically-based ATLAS simulator (SILVACO). This finite-element computer simulator numerically solves a set of coupled Poisson's, continuity, and drift-diffusion equations within a user-defined two-dimensional mesh.

III. CHARGE-CARRIER DISTRIBUTION IN AN ORGANIC SEMICONDUCTOR

The aim of this section is to find how the injected holes from the source (p_s) and the gate-induced holes at the channel (p_{ch}) are distributed along the thickness of the organic layer (y -axis) in the model transistor depicted in Fig. 2. Throughout this study, a two-dimensional model will be developed based on the following hypotheses: 1) All charge carriers are "injected" into the organic semiconductor; 2) hole-only conduction is considered; 3) the gradual channel approximation holds. We recently confirmed that unintentionally doped organic semiconductors are fully depleted so that the above assumption 1) can be made [13]. By this simplification, an organic semiconductor is rather an insulator that can only 'transport' the carriers given by external circumstances (injection or illumination) and we can revisit the classical theory on the metal/insulator junction that

has been intensively dealt with in the early days of solid-state electronics through the 1940s and 1950s. We will first briefly recapitulate traditional models in Section III-A and propose a new approach in Section III-B.

A. Revisiting classical models

Imagine a one-dimensional insulator (or undoped semiconductor) in contact with a charge reservoir (normally a metal electrode) at $y = 0$ that extends toward the positive y -direction up to $y = d$ (d is the thickness of the semiconductor). The electrostatic distribution of injected carriers $p(y)$ can be estimated by simultaneously analyzing Poisson's equation (1) and the transport (drift-diffusion) equation (2)

$$\frac{dF}{dy} = \frac{qp(y)}{\epsilon_s}, \quad (1)$$

$$J_p = qp\mu F - qD \frac{dp}{dy}, \quad (2)$$

where $F(y)$ is the electric field, q the elementary charge, $p(y)$ the hole concentration, ϵ_s the permittivity of the semiconductor, J_p the net hole current density, μ the hole mobility, and D the hole diffusion coefficient. These two equations are then merged by substituting p in (2) using (1) and by taking Einstein relation $D/\mu = kT/q$, where k is the Boltzmann constant and T the absolute temperature. This gives

$$J_p = \epsilon_s \mu \left(F \frac{dF}{dy} - \frac{kT}{q} \frac{d^2 F}{dy^2} \right), \quad (3)$$

which is the fundamental equation of the given physical system to be solved. At thermal equilibrium, the net current is zero (the drift current and the diffusion current compensate each other) so that

$$F \frac{dF}{dy} - \frac{kT}{q} \frac{d^2 F}{dy^2} = 0. \quad (4)$$

This can be integrated once to

$$\left(\frac{q}{2kT} \right)^2 F^2 - \frac{q}{2kT} \frac{dF}{dy} = -g^2, \quad (5)$$

where g is an integration constant.

Mott and Gurney first derived the solution of (5) for a semi-infinite semiconductor ($d \rightarrow \infty$) [14]. In this case, both $F(y)$ and dF/dy go to zero when $y \rightarrow \infty$, so that $g = 0$ and (5) reduces to

$$F^2 - \frac{2kT}{q} \frac{dF}{dy} = 0. \quad (6)$$

The solution for the electric field is reached by separating variables,

$$F(y) = \left(-\frac{2kT}{qy_0} \right) \left(\frac{1}{1 + y/y_0} \right) = \frac{F_0}{1 + y/y_0}, \quad (7)$$

where y_0 is another integration constant. The hole distribution $p(y)$ is given by the first derivative of $F(y)$;

$$p(y) = \left(\frac{2\epsilon_s kT}{q^2 y_0^2} \right) \left(\frac{1}{1 + y/y_0} \right)^2 = \frac{p_0}{(1 + y/y_0)^2}. \quad (8)$$

F_0 and p_0 are respectively the electric field and the hole concentration at the junction ($y = 0$). Equations (7) and (8) are intended to make more visible the physical meaning of y_0 , which can be viewed as a characteristic length over which the boundary value (F_0 or p_0) is distributed from the junction interface. The value of y_0 can be determined from the boundary value of either F_0 or p_0 . For the following discussion, a relationship between y_0 and p_0 is particularly useful. From (8), we have

$$y_0 = \sqrt{\frac{2\epsilon_s kT}{q^2 p_0}}, \quad (9)$$

meaning that the higher the initial carrier density p_0 is, the smaller y_0 becomes. If y_0 is small, the carriers are densely concentrated at the junction and do not spread far away from the injecting surface. Even though the Mott-Gurney model provides meaningful insight into the charge distribution, its usage should be limited to very thick organic crystals and this model cannot be safely applied to thin organic films.

Skinner stepped forward and developed more general solutions to (5) [15]. It means that one can challenge the 'finite' junction without forcing g to zero. The author actually separated the cases by the sign of the integration constant and obtained separate sets of solutions depending on this sign. An essential boundary condition for the finite semiconductor is $F(d) = 0$ because there cannot be any current flowing into or out of the semiconductor at the surface $y = d$. The injected holes (positive charges) make the only contribution to the space charge in Poisson's equation. Consequently, the sign of dF/dy is always

positive through the whole semiconductor thickness. In other words, $F(0)$ is negative and $F(y)$ approaches zero from $y = 0$ to $y = d$. At $y = d$, F becomes zero by the boundary condition and dF/dy remains positive. Therefore, the right-hand term in (5) is negative and the corresponding solution is the trigonometric function in [15], which can be written in the form;

$$F(y) = -\frac{qp_0gy_0^2}{\epsilon_s} \cot(gy + \arcsin gy_0), \quad (10)$$

$$p(y) = \frac{p_0g^2y_0^2}{\sin^2(gy + \arcsin gy_0)}. \quad (11)$$

Here, p_0 always represents the hole concentration at $y = 0$ and (9) remains valid. In order to estimate the constant g , we introduce the boundary condition $F(d) = 0$. From (10), this gives

$$\cot(gd + \arcsin gy_0) = 0, \quad (12)$$

which can be further simplified by using trigonometric identities, resulting in

$$gy_0 = \cos gd. \quad (13)$$

By putting (13) into (11), we can write

$$p(y) = \frac{p_0 \cos^2 gd}{\cos^2 g(d-y)}, \quad (14)$$

where $0 \leq y \leq d$.

A limitation of Skinner's approach looks apparent at this point. Although this model gives exact solutions for thin-film cases, (13) does not lead to an analytical expression for g and, consequently, the final solution requires numerical computation.

B. Approximate solutions

Now let us return to the two-dimensional semiconductor and discuss how the initial carrier densities at the insulator/semiconductor interface ($y = 0$) are determined in the coplanar OFET architecture (see the inset in Fig. 2). The carrier density at a metal/semiconductor interface is dictated by Boltzmann's statistics [16] so that p_{s0} (the source carrier density at $y = 0$) is strongly injection-limited following

$$p_{s0} = N_v \exp\left(-\frac{E_b}{kT}\right), \quad (15)$$

where N_v is the effective density of states at the HOMO edge. The hole barrier height E_b corresponds the energy between the electrode Fermi level and the semiconductor HOMO level. The channel carriers, on the other hand, are induced by the gate capacitance and can be estimated by

$$Q_{ch} = C_i |V_G - V_T| = q \int_0^d p_{ch}(y) dy, \quad (16)$$

where Q_{ch} is the total channel charge per unit area, C_i the insulator capacitance per unit area, and V_T the threshold voltage. The functional form of $p_{ch}(y)$ will be derived below but it is helpful to know the boundary value already here. The channel hole concentration at $y = 0$ is approximate to

$$p_{ch0} \approx \frac{Q_{ch}^2}{2\epsilon_s kT} = \frac{C_i^2 |V_G - V_T|^2}{2\epsilon_s kT}. \quad (17)$$

The characteristic distribution lengths for the source and the channel charges are then defined by (9), thus $y_{s0} = \sqrt{2\epsilon_s kT/q^2 p_{s0}}$ and $y_{ch0} = \sqrt{2\epsilon_s kT/q^2 p_{ch0}}$ respectively.

We can infer from (15) and (17) that E_b and V_G are the principal parameters for the source and channel distribution of charges. The results presented in Fig. 3 support this statement and give another important implication for the modeling. Fig. 3 shows the results calculated by (15) and (17) with $N_v = 10^{20} \text{ cm}^{-3}$, $T = 300 \text{ K}$, $\epsilon_s = 3.6 \times \epsilon_0$, $C_i = 2.3 \text{ nF/cm}^2$, and $V_T = 0 \text{ V}$ (ϵ_0 is the permittivity of vacuum). Typical organic materials exhibit a transport band width of around 500 meV, which is much larger than the thermal energy kT . In this case, N_v should be lower than the total molecular density and 10^{20} cm^{-3} is a realistic value for N_v . At variance with the charge distribution in staggered OFETs in which the gate-induced charges are evenly distributed over the whole semiconductor/insulator interface [12], here p_{s0} is much lower than p_{ch0} due to the high injection barrier. Another key feature of Fig. 3 is that y_{s0} normally exceeds the thickness of an organic thin-film, whereas y_{ch0} is far smaller than the film thickness. This finding enables an independent modeling of $p_s(y)$ and $p_{ch}(y)$ by means of an approximation method.

The main idea is to develop an analytical form of (14) by approximating the cosine function in (13). A linear (or a first-order) approximation of any given function $f(z)$ is defined at the vicinity of $z = a$ by

$$f(z) \approx f(a) + f'(a)(z - a). \quad (18)$$

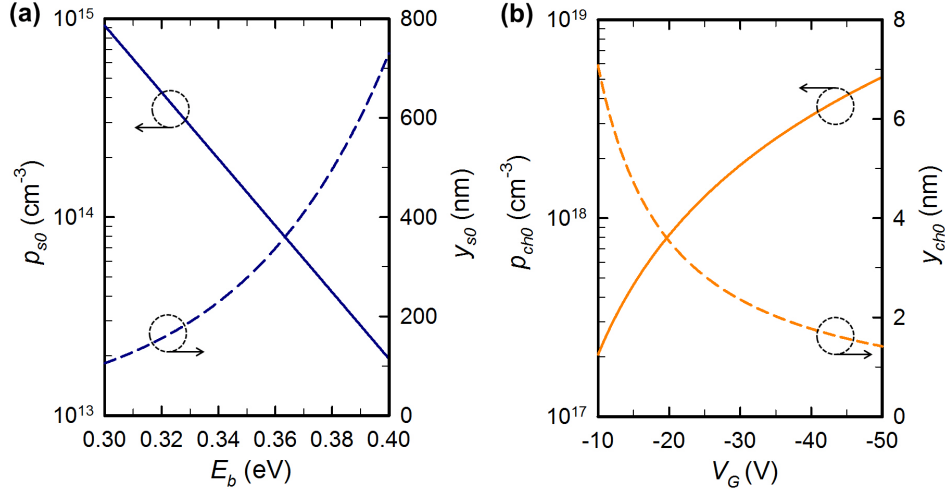


Fig. 3. (a) Source distribution factors (p_{s0} and y_{s0}) as a function of E_b and (b) channel distribution factors (p_{ch0} and y_{ch0}) as a function of V_G . The solid lines indicate the initial hole concentrations and the dashed lines correspond to the distribution lengths. Note how different the order of the vertical axis is in plot (a) and (b).

If $f(z) = \cos z$, we get

$$\cos z \approx \cos a + (-\sin a)(z - a). \quad (19)$$

First, for the source carriers $p_s(y)$, we rewrite (13) as

$$g_s y_{s0} = \cos g_s d, \quad (20)$$

where the subscript 's' refers to the 'source'. Because $y_{s0} \gg d$, we can approximate $\cos g_s d$ where $g_s d$ is close to zero. Under this condition, we can say

$$g_s y_{s0} = \cos g_s d \approx 1, \quad (21)$$

and therefore

$$g_s \approx \frac{1}{y_{s0}}. \quad (22)$$

Then if we use (22) to replace g , (14) finally changes into

$$p_s(y) = p_{s0} \frac{\cos^2\left(\frac{d}{y_{s0}}\right)}{\cos^2\left(\frac{d-y}{y_{s0}}\right)}. \quad (23)$$

Next, another approximation is needed for the channel carriers $p_{ch}(y)$. Starting again from (13),

$$g_{ch} y_{ch0} = \cos g_{ch} d, \quad (24)$$

where the subscript 'ch' refers to the 'channel'. This time, $y_{ch0} \ll d$ so that $\cos g_{ch} d$ should be developed near $g_{ch} d = \pi/2$. Referring to (19), we get

$$g_{ch} y_{ch0} = \cos g_{ch} d \approx \frac{\pi}{2} - g_{ch} d, \quad (25)$$

and

$$g_{ch} \approx \frac{\pi}{2(d + y_{ch0})}. \quad (26)$$

The channel carrier distribution function $p_{ch}(y)$ is now given from (14) and (26), after some manipulation steps, by

$$p_{ch}(y) = p_{ch0} \frac{\sin^2\left(\frac{\pi}{2} \frac{y_{ch0}}{d}\right)}{\sin^2\left(\frac{\pi}{2} \frac{y_{ch0} + y}{d}\right)}. \quad (27)$$

Now one can reexamine the integration in (16) and see that (17) is correct under the condition that $y_{ch0} \ll d$.

It is worth emphasizing here that our approximate model [(23) and (27) with (15) and (17)] provides analytical expressions that explicitly contain the thickness parameter d . It means that this strategical development overcomes the limitation of the two classical models summarized in Section III-A and assures its general applicability to the thin film-based OFETs. Fig. 2 shows the reliability of the approximate solutions. The parameters used here in both the analysis and the simulation are those listed above for Fig. 3 with $d = 50$ nm, $E_b = 0.3$ eV, and $V_G = -20$ V. It is shown that the analytical model predicts the numerical simulation results with satisfying precision.

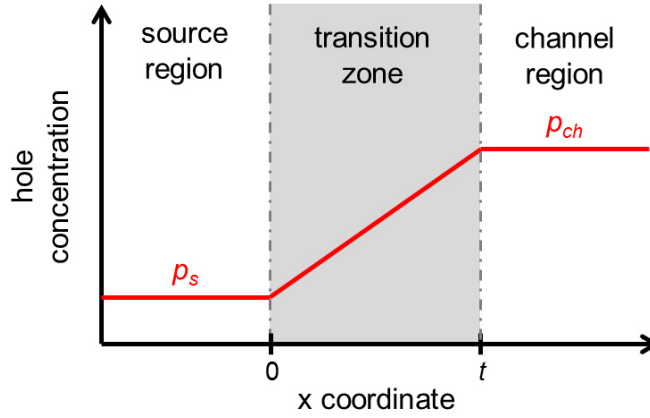


Fig. 4. A conceptual representation for the hole concentration near the transition zone that is located from $x = 0$ to $x = t$. As explained in Section IV-A, the x -directional change is modeled by an exponential function so the vertical axis in the figure is in logarithmic scale.

IV. CHARGE-BASED CONTACT RESISTANCE MODEL

Now that we have a two-dimensional picture of the charge distribution inside the organic film in coplanar OFETs, we develop a charge-based contact resistance model in this section. Section IV-A will deal with a mathematical formulation of R_c in the transition zone and the effect of the critical parameters will be discussed in Section IV-B

A. Resistance of the transition zone

We realize that there is an abrupt transition of the hole concentration at $x = 0$ due to the huge difference between $p_s(y)$ and $p_{ch}(y)$. It is this carrier-density transition zone that accounts for the origin of R_c because the hole concentration in this zone is much lower than that in the conducting channel, due to the effect of p_s penetrating into the channel region. Now let us contemplate what happens at this source/channel interface where two independent distribution functions overlap (Fig. 4). There exist concentration tails along the x -direction characterized by the Debye length of the channel carriers (x_{ch}) and that of the source carriers (x_s). They are defined by $x_{ch} = \sqrt{\epsilon_s kT/q^2 p_{ch}}$ and $x_s = \sqrt{\epsilon_s kT/q^2 p_s}$ [16]. Because $p_{ch} \gg p_s$, $x_{ch} \ll x_s$ and we can neglect the contribution of x_{ch} so that the transition from p_s to p_{ch} can be simplified to a single exponential function

$$p(x) = p_s \exp\left(\frac{x}{x_s}\right), \quad (28)$$

Then the thickness t of the transition zone in Fig. 4 is estimated by

$$p(t) = p_s \exp\left(\frac{t}{x_s}\right) = p_{ch}, \quad (29)$$

$$t = x_s \ln\left(\frac{p_{ch}}{p_s}\right). \quad (30)$$

Here, it is worth mentioning that t also varies along the semiconductor thickness as p_{ch} and p_s change together along the y -direction. Taking the parameters used in Section III-B, the calculated t is $0.51 \mu\text{m}$ at $y = 0$. It means that only a narrow region of the entire channel near the source electrode is affected by low p_s .

The contact resistance R_c is calculated from an estimation of the average hole concentration in the transition zone (or R_c zone), done by integrating the local conductivity over the entire thickness. Keeping this approach in mind, the mean hole concentration p_m throughout the R_c zone can be defined by

$$p_m = \frac{1}{t} \int_0^t p(x) dx = \frac{p_s}{t} \int_0^t \exp\left(\frac{x}{x_s}\right) dx, \quad (31)$$

where (28) is used. By inserting (29) and (30) and using $p_{ch} \gg p_s$, we get

$$p_m = \frac{p_{ch} - p_s}{\ln(p_{ch}/p_s)} \approx \frac{p_{ch}}{\ln(p_{ch}/p_s)}, \quad (32)$$

which shows that the balance between p_s and p_{ch} determines the average concentration and p_m is also a function of y . Now we can calculate the elemental conductance dG_c of the volume element delimited by W (channel width), $t(y)$, and dy

$$dG_c = q\mu W \frac{p_m(y)}{t(y)} dy, \quad (33)$$

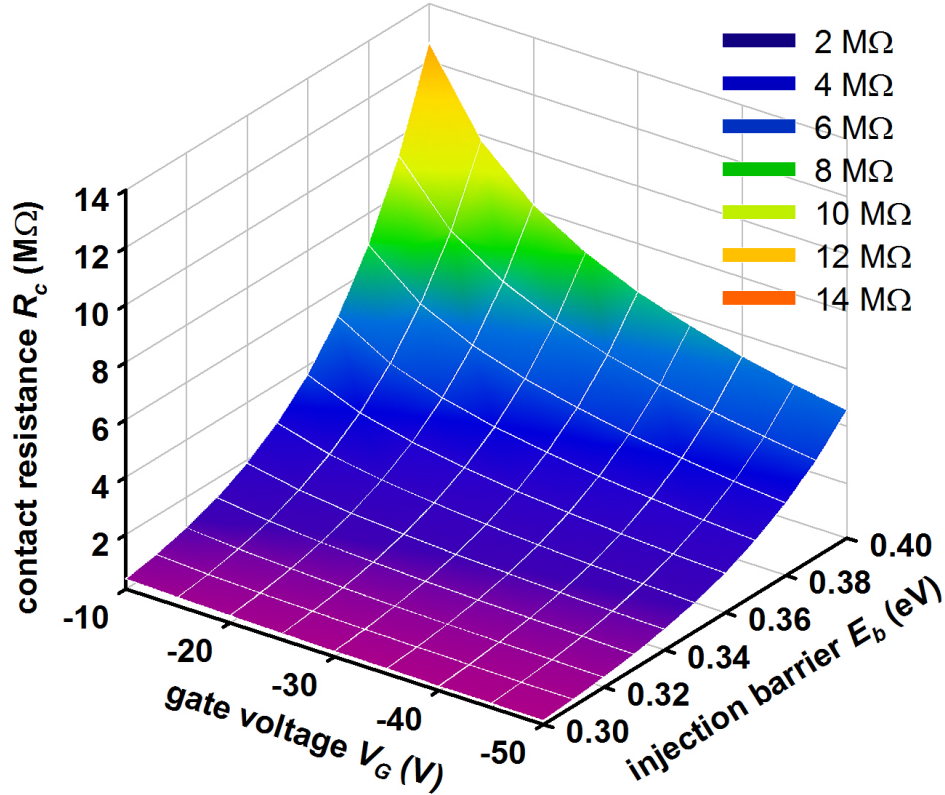


Fig. 5. R_c determined by (34) with a variation of V_G and E_b . The fixed parameters are as follows; $N_v = 10^{20} \text{ cm}^{-3}$, $T = 300 \text{ K}$, $\epsilon_s = 3.6 \times \epsilon_0$, $C_i = 2.3 \text{ nF/cm}^2$, $V_T = 0 \text{ V}$, $d = 50 \text{ nm}$, $W = 500 \text{ }\mu\text{m}$, and $\mu = 0.2 \text{ cm}^2/\text{V}\cdot\text{s}$.

where the hole mobility μ is assumed to be constant at this moment. R_c is finally obtained, by replacing $t(y)$ and $p_m(y)$ using (30) and (32),

$$R_c = \frac{1}{G_c} = \frac{\sqrt{\epsilon_s kT}}{q^2 \mu W} \left[\int_0^d \frac{p_{ch}(y) \sqrt{p_s(y)}}{[\ln(p_{ch}(y)/p_s(y))]^2} dy \right]^{-1}. \quad (34)$$

Note that, from (34), it is possible to predict the exact value of R_c when the distribution functions for $p_s(y)$ and $p_{ch}(y)$ are known.

B. Effect of the parameters

Numerically calculated R_c values are plotted in Fig. 5 with varying V_G and E_b . The charge-distribution functions [$p_s(y)$ and $p_{ch}(y)$] developed in Section III-B were inserted to (34). All fixed parameters are summarized in the caption to Fig. 5. We can state, from this result, that the theoretical charge-based model well predicts the decrease of R_c with increasing $|V_G|$, which is often experimentally observed, though not sufficiently understood in the case of coplanar OFETs [17], [18], [19], [20]. Furthermore, it can be inferred that the degree of dependency between V_G and R_c is accentuated with higher injection barriers. Finally, it should be noted that the hole mobility μ is considered constant here, which restricts the analysis to defect-free, highly pure crystalline semiconductors [21]. When substantial trap states exist, μ should be regarded as the ‘effective’ mobility determined by the ratio of free to total carrier density. This results in the dependence of the measured mobility on the gate voltage as will be discussed in the next section.

V. APPLICATION TO EXPERIMENTAL RESULTS

This section is dedicated to the analysis of experimental results on fabricated OFETs with the R_c model. In Section V-A, the basic electrical properties of pentacene-based OFETs will be presented. Then, in Section V-B, we will concisely summarize how the transmission-line method works for experimentally extracting R_c . Finally, the V_G -dependent mobility and its influence on R_c will be discussed in Section V-C.

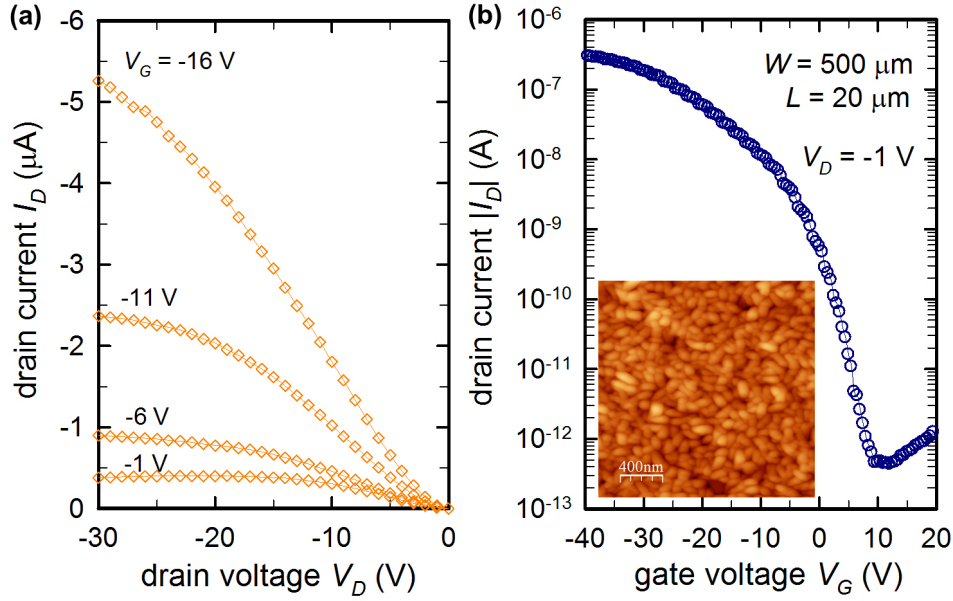


Fig. 6. Measured electrical performance of a pentacene transistor fabricated with the bottom-gate, bottom-contact geometry. (a) Output characteristics and (b) transfer characteristics. The inset of (b) is an AFM image taken on the 50 nm-thick pentacene film in the channel region (scan size: $2 \times 2 \mu\text{m}^2$).

A. Output and transfer curves

The electrical performance of a representative transistor is shown in Fig. 6. The channel width W and length L of this transistor are $500 \mu\text{m}$ and $20 \mu\text{m}$ respectively. The slight upward bending of the output curves [Fig. 6(a)] at low drain voltage (V_D) is direct evidence for a non-linear parasitic contact effect [18]. Hence, it can be predicted that there is non-negligible contribution of R_c to the current in the fabricated device. A linear-regime transfer curve is shown in Fig. 6(b). One can see that the off-state current is extremely low and close to the detection limit of the measurement system (10^{-12} A), assuring an excellent gate-insulation by the SU-8 film. The AFM image in Fig. 6(b) shows relatively small domain size of the order of 100 nm. These small and uniform grains could be attributed to the three-dimensional growth of pentacene which contrasts with the two-dimensional layer-by-layer growth that results in large, dendritic grains [22].

B. Transmission-line method

The transmission-line method (TLM) is a widely-used technique for the extraction of R_c from I - V data [23], [24], [25]. It is assumed that the source-to-drain current path is equivalent to a series combination of contact resistance R_c and channel resistance R_{ch} (inset in Fig. 7). The TLM is also strongly based on the assumption that R_c is not a function of L but R_{ch} is proportional to L [26]. At low V_D (linear regime), the relationship between I_D and V_D of this circuit can be expressed as

$$I_D = \frac{V_D}{R_{on}} = \frac{V_D}{R_c + R_{ch}} = \frac{V_D}{R_c + \left[\frac{W}{L}\mu C_i|V_G - V_T|\right]^{-1}}, \quad (35)$$

where the linear-regime channel conductance is used to estimate R_{ch} . R_{on} is the on-state resistance that can be directly obtained from measured V_D and I_D by

$$R_{on} = \frac{V_D}{I_D} = R_c + \frac{L}{W\mu C_i|V_G - V_T|}. \quad (36)$$

Width-normalized resistance is more practical for the purpose of comparing device sets with different W so it is useful to multiply (36) by W and get

$$R_{on} \times W = R_c \times W + \frac{L}{\mu C_i|V_G - V_T|}. \quad (37)$$

To apply the TLM, we first draw $R_{on}W$ versus L and extrapolate the linear regression line to zero L to read the R_cW value. Fig. 7 shows the experimental data on pentacene OFETs. The deviation of the data points from the regression lines is minimal and it makes sure that the fabricated OFETs well satisfy the basic assumptions of the TLM. It is clear that R_c decreases with increasing $|V_G - V_T|$ as the intercept to the vertical axis moves downward. V_T for those three transistors were evaluated from the saturation current and no significant variation was observed so that we can use an average V_T of -4 V. Although not often realized, it is important to note here that the TLM can also be used to estimate μ as a function of $|V_G - V_T|$ because the ‘slope’ of the regression line usually varies with V_G (see Fig. 7) and this slope contains the parameter μ by (37).

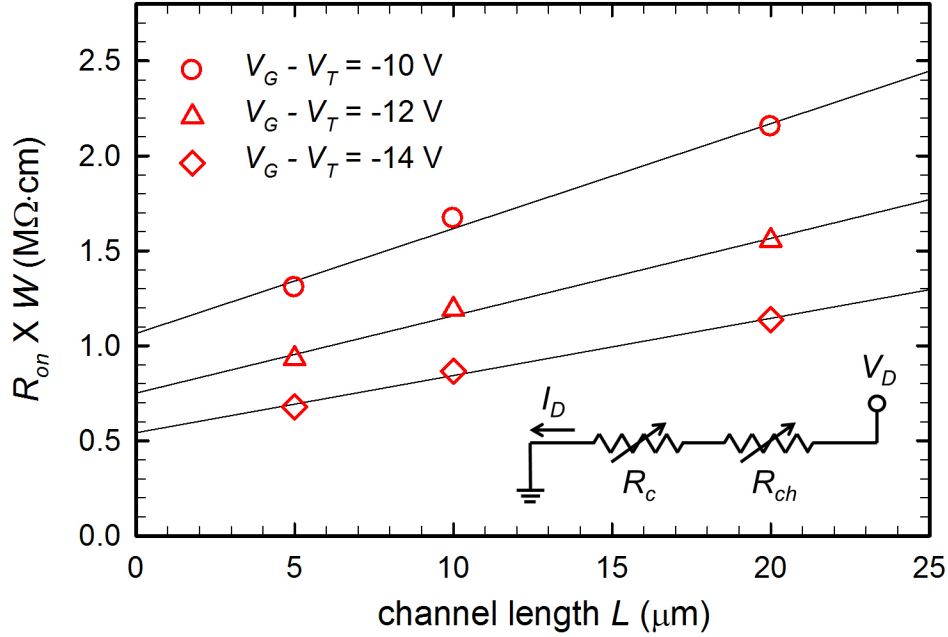


Fig. 7. $R_{on}W$ versus L plot for the transmission-line method (TLM). The inset is the equivalent circuit of the on-state conduction path that consists of a series connection of the contact and channel resistances. Note that R_c and R_{ch} are drawn as variable resistors because both of them are supposed to be V_G -controlled.

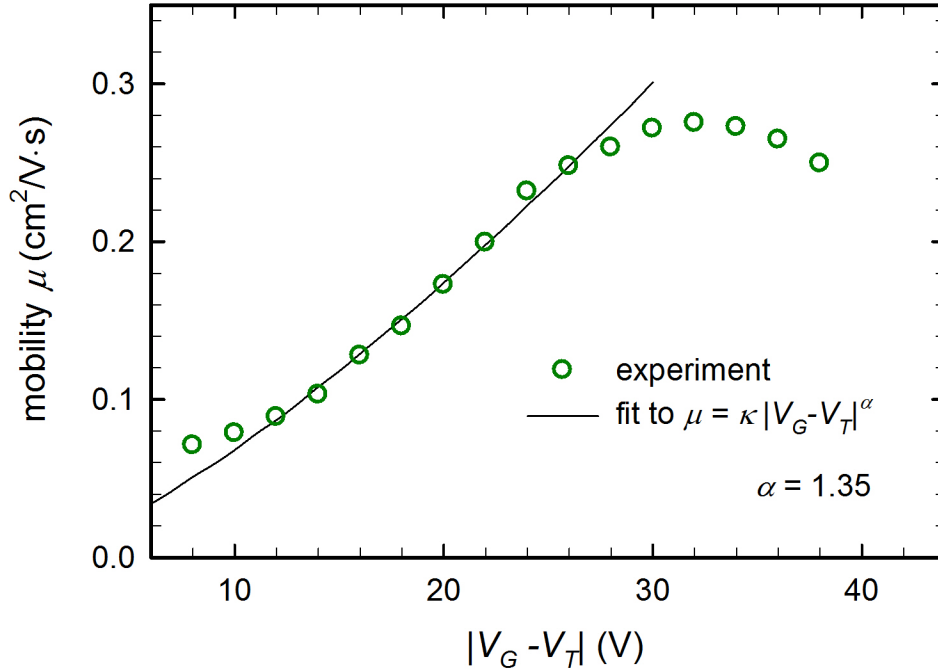


Fig. 8. Hole mobility as a function of $|V_G - V_T|$ extracted by the TLM. The solid line is a fit to the trap-filling model at low $|V_G|$. The decrease in the mobility at higher $|V_G|$ can be attributed to the field-induced mobility degradation.

C. Effect of the gate-voltage dependent mobility

The extracted hole mobility μ as a function of $|V_G - V_T|$ is shown in Fig. 8, which indicates that the variation of μ is significant and does not follow a simple monotonous behavior. We infer that the two distinct regimes are dominated by two different mechanisms. First, the rise in μ at low $|V_G|$ can be adequately described by the gradual filling of trap states as the Fermi level at the semiconductor/insulator interface approaches the transport orbital (HOMO in the case of p-type materials). This is reasonable because a polycrystalline pentacene film contains a large number of trapping sites, most of which located at the grain boundaries [27], [28]. We refer to the model of Horowitz *et al.* [29], [26] and fit the mobility in this regime

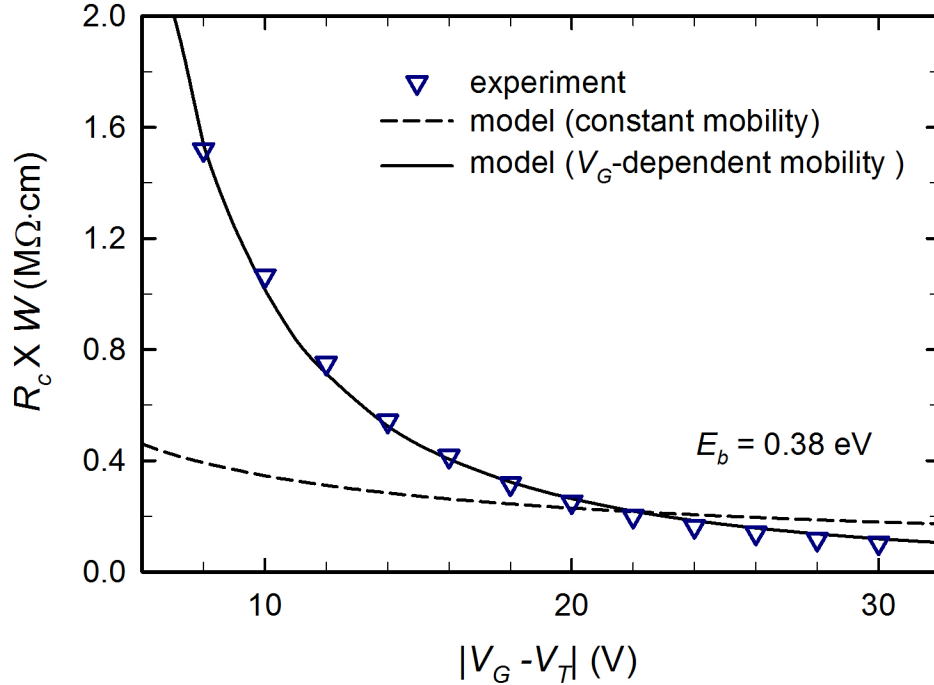


Fig. 9. TLM-extracted $R_c W$ as a function of $|V_G - V_T|$ in comparison to the charge-based model developed in Section IV. Note that, if a constant mobility is assumed (here $0.2 \text{ cm}^2/\text{V}\cdot\text{s}$), the V_G -dependence of R_c is underestimated. When we take the V_G -dependent mobility into account, the experimental results could be well fitted by the model. This method also enables an estimation of the injection barrier E_b .

($|V_G - V_T| < 30 \text{ V}$) to the equation

$$\mu = \kappa |V_G - V_T|^\alpha. \quad (38)$$

This model is based on the MTR (multiple trapping and release) process with an exponential density of states (DOS) near the band edge. The parameters κ and α are then related to the trap DOS. The exponent α is directly linked to the trap characteristic temperature T_c by $\alpha + 1 = (T_c/T)$. The extracted α is 1.35 in Fig. 8 and the corresponding T_c is 705 K. If we convert this value into energy scale, the trap distribution width $E_t = kT_c$ is 61 meV, which is in good agreement with a recent comprehensive review on the trap DOS in pentacene field-effect transistors [30]. Next, the slight decrease in μ at higher $|V_G - V_T|$ can be interpreted by the field-induced mobility degradation [22]. It is likely that the mobility near the insulator surface is lower than that at the bulk region due to various surface scattering agents. When $|V_G|$ becomes high enough, field-induced holes are more concentrated at this low-mobility near-insulator region so that the effective mobility of the conduction path could be reduced.

Fig. 9 shows how seriously the V_G -dependent mobility affects the charge-based R_c model. Here, the TLM-extracted R_c values are plotted as a function of $|V_G - V_T|$. As expected, R_c decreases rapidly with increasing $|V_G - V_T|$. We simply replaced μ in (34) by (38) and calculated R_c to compare with the experimental curve. Note that the entire curve in Fig. 8 cannot be modeled by a simple analytical expression, so we only took the trap-dominated regime ($|V_G - V_T| < 30 \text{ V}$) for the analysis in Fig. 9. As emphasized in Section IV-B, V_G and E_b are the foremost parameters that govern R_c . Therefore, by optimizing the TLM-extracted curve with the model, we could effectively estimate the injection barrier E_b at the Au/pentacene interface in the fabricated OFETs. One can see that the model-calculated curve is in very good agreement with the experimental curve with E_b of 0.38 eV. When we calculated R_c with a constant mobility of $0.2 \text{ cm}^2/\text{V}\cdot\text{s}$, the model could not accurately predict the experimental results.

In the literature, there has been a question about how sometimes R_c is less sensitive to V_G or even assumed to be constant [31], [12] while more often R_c is strongly dependent on V_G . For coplanar OFETs, the whole picture of this study can suggest two answers: First, the injection barrier E_b plays an important role on the dependence of R_c on V_G (Fig. 5) thus the material combination of the metal and the semiconductor is basically crucial [32]. Second, V_G -dependent mobility can either intensify or diminish the slope of an R_c versus V_G curve, because μ can either increase or decrease (or even remain stable) with V_G , depending on various geometrical and/or electrical mechanisms [22], [29], [33], [34].

VI. CONCLUSION

In this study, a physical model for coplanar OFETs has been presented. Starting from the coupled Poisson's and transport equations, we could formulate an approximate analytical model for the charge distribution inside an organic semiconductor. The distribution functions were inspired by the classical theory of metal/insulator contacts because unintentionally doped organic

semiconductors are characterized by very low thermal carrier density. The origin of the contact resistance was attributed to a low-carrier-density zone at the source/channel edge. An equation for the contact resistance was suggested and the model could explain the gate-voltage dependence of the contact resistance. Pentacene-based OFETs were fabricated and analyzed by the transmission-line method. It was found that, in most cases, the mobility is strongly dependent on the gate-voltage and this effect can further complicate the dependence of the contact resistance on the gate-voltage. We believe that this model can be widely applied for interpreting and predicting the behavior of coplanar OFETs and will deepen the fundamental understanding of the device physics of organic devices.

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